

**N-Channel 30V(D-S) MOSFET, ESD Protected**
**GENERAL DESCRIPTION**

The ME90N03 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

**FEATURES**

- $R_{DS(ON)} \leq 4.8\text{m}\Omega @ V_{GS}=10\text{V}$
- $R_{DS(ON)} \leq 9\text{m}\Omega @ V_{GS}=4.5\text{V}$
- ESD Protected
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

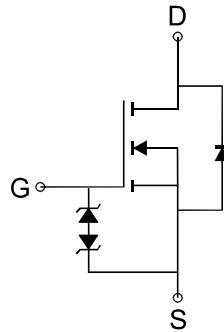
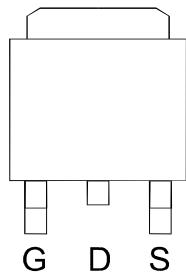
**APPLICATIONS**

- Power Management in Note book
- Battery Powered System
- DC/DC Converter
- Load Switch

**PIN CONFIGURATION**

(TO-252-3L)

Top View



Ordering Information: ME90N03 (Pb-free)

ME90N03-G (Green product-Halogen free)

**Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  Unless Otherwise Noted)**

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_c=25^\circ\text{C}$	$I_D$	74	A
	$T_c=70^\circ\text{C}$		59	
Pulsed Drain Current		$I_{DM}$	296	A
Maximum Power Dissipation	$T_c=25^\circ\text{C}$	$P_D$	42	W
	$T_c=70^\circ\text{C}$		27	
Operating Junction Temperature		$T_J$	-55 to 150	°C
Thermal Resistance-Junction to Ambient*		$R_{\theta JC}$	3	°C/W

 \* The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper


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**Electrical Characteristics (T<sub>C</sub> =25°C Unless Otherwise Specified)**

Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250 μA	30			V
V <sub>G(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA	1.2		3	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±16V			±10	μA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
R <sub>D(on)</sub>	Drain-Source On-State Resistance <sup>a</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> = 30A		4	4.8	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> = 15A		7	9	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =2.7A, V <sub>GS</sub> =0V		0.8	1.2	V
<b>DYNAMIC</b>						
Q <sub>g</sub>	Total Gate Charge(10V)	V <sub>DS</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =17A		53		nC
Q <sub>g</sub>	Total Gate Charge(4.5V)	V <sub>DS</sub> =15V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =17A		27		
Q <sub>gs</sub>	Gate-Source Charge			11		
Q <sub>gd</sub>	Gate-Drain Charge			14		
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1.0MHz		2400		pF
C <sub>oss</sub>	Output Capacitance			350		
C <sub>rss</sub>	Reverse Transfer Capacitance			110		
R <sub>g</sub>	Gate-Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz		0.9		Ω
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V, R <sub>L</sub> =15Ω I <sub>D</sub> =1A, V <sub>GEN</sub> =10V R <sub>G</sub> =6Ω		23		ns
t <sub>r</sub>	Turn-On Rise Time			17		
t <sub>d(off)</sub>	Turn-Off Delay Time			76		
t <sub>f</sub>	Turn-Off Fall Time			15		

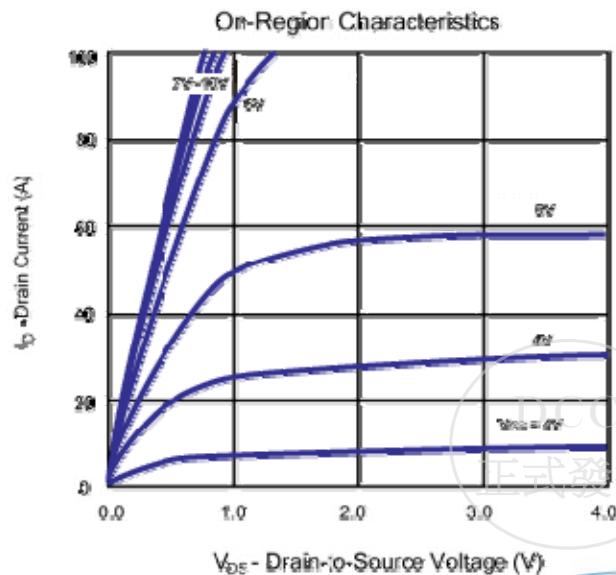
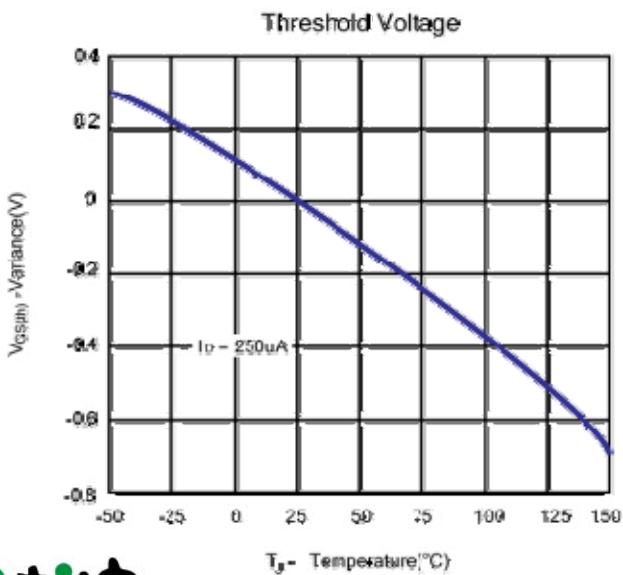
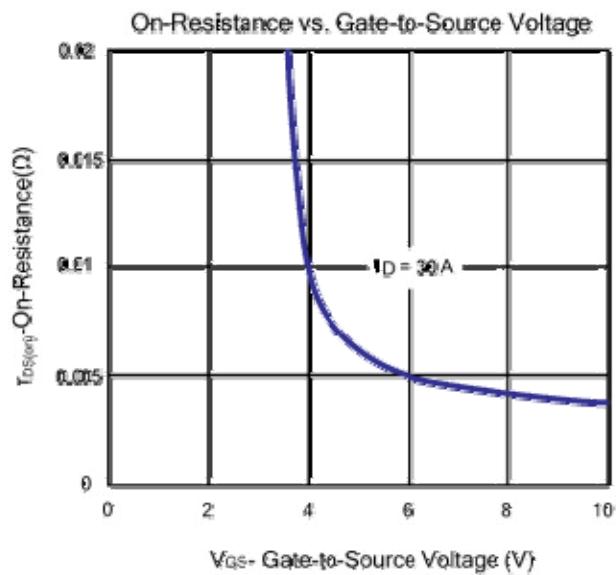
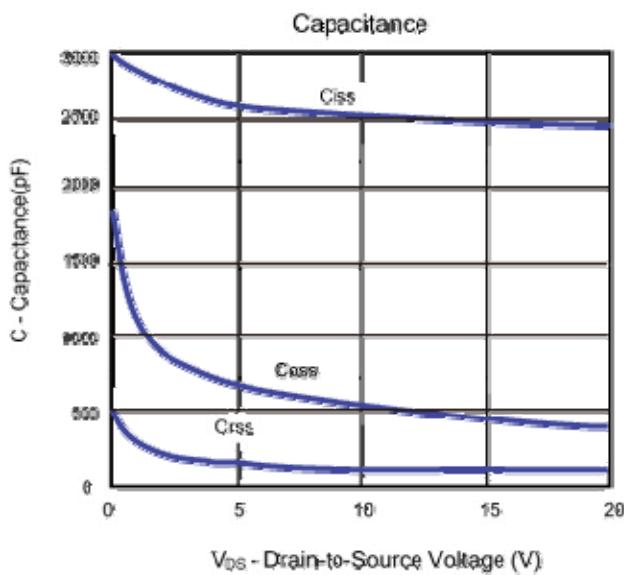
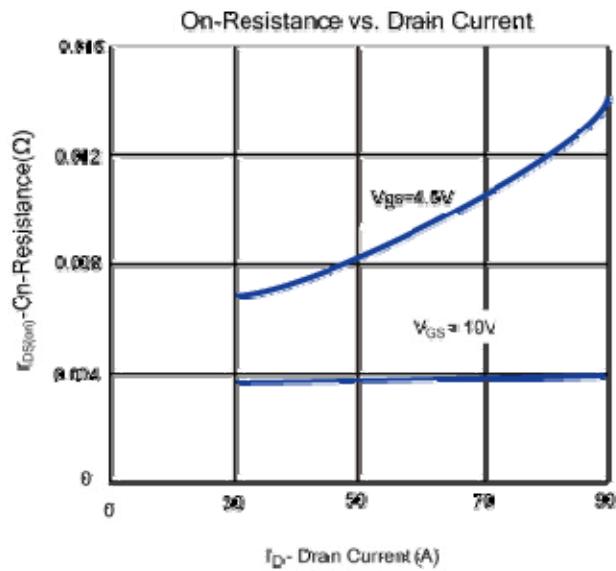
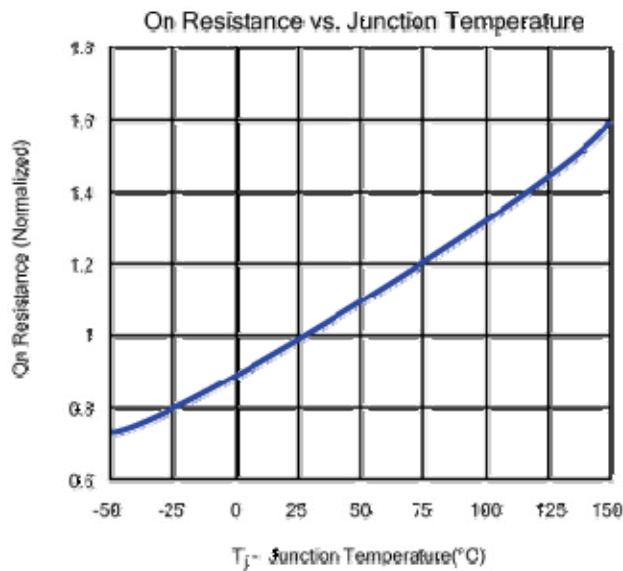
Notes: a. Pulse test: pulse width≤ 300us, duty cycle≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



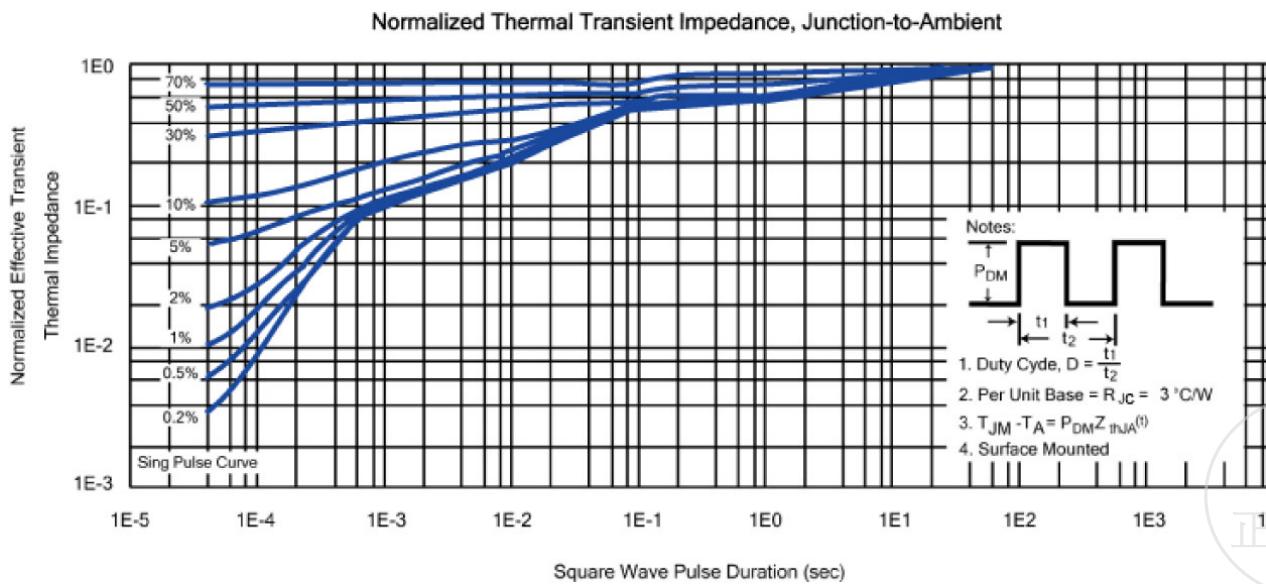
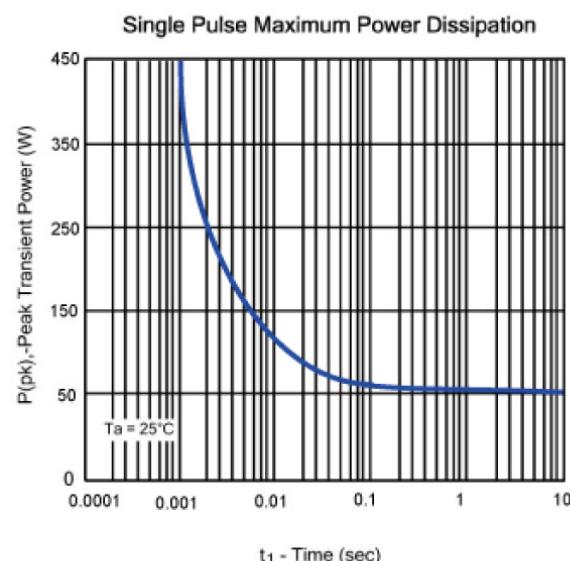
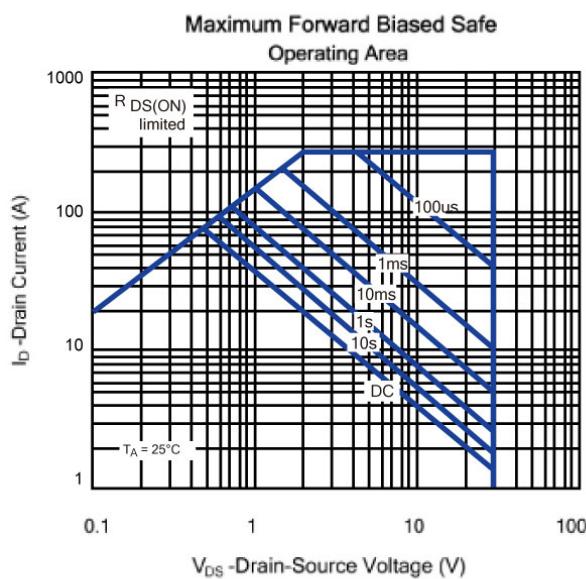
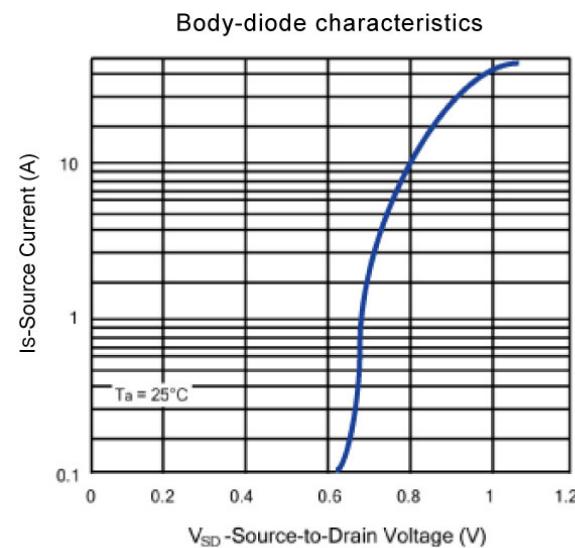
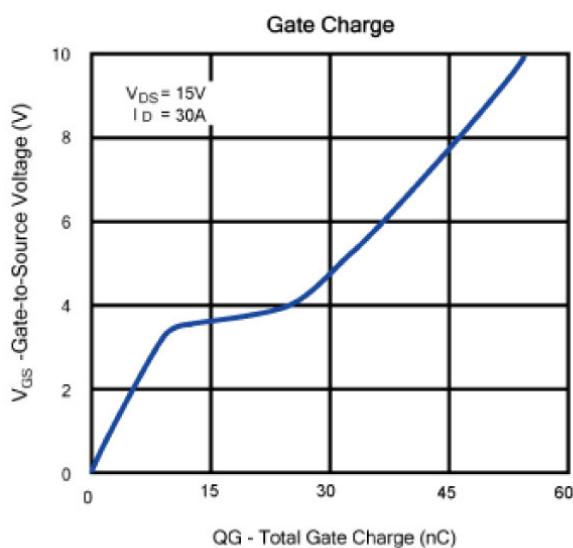
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Typical Characteristics (T<sub>J</sub> = 25°C Noted)

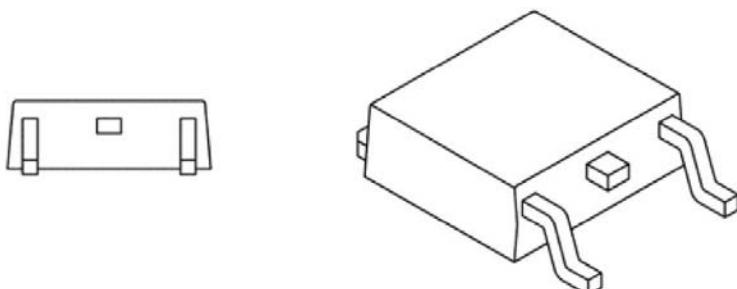
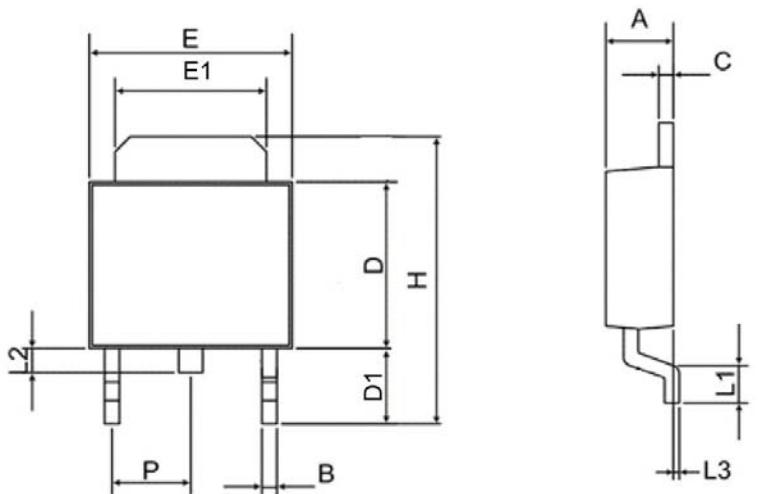


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### TO-252-3L Package Outline



SYMBOL	MIN	MAX
A	2.10	2.50
B	0.40	0.90
C	0.40	0.90
D	5.30	6.30
D1	2.20	2.90
E	6.30	6.75
E1	4.80	5.50
L1	0.90	1.80
L2	0.50	1.10
L3	0.00	0.20
H	8.90	10.40
P	2.30 BSC	



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